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Table of Contents

Volume 9 Number 3

August 2018

Research on Innovation Posture of Automated Driving Technology Based on Patentometrics

Z. G. Zhang, X. Y. Chen, J. M. Huang.....137

A Novel Method to Verify Gamma Knife Radioactive Source Count

H.-T. Tu, C.-S. Chang, C.-Y. Chuang, C.-W. Huang, W.-J. Li, T.-C. Wu, F.-Y. Feng, Z.-P. Ho, C.-F. Huang.....154

Inquiry into FDI Pattern of China and the Economies along the Belt & Road

J. R. Liu, Y. Liu.....161

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